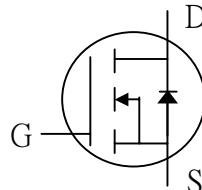
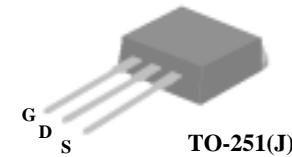
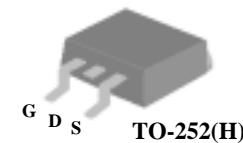


**N-CHANNEL ENHANCEMENT-MODE
POWER MOSFET**
Low on-resistance**Capable of 2.5V gate drive****Low drive current****Surface mount package**

BV_{DSS}	20V
$R_{DS(ON)}$	14mΩ
I_D	45A

Description

Power MOSFETs from Silicon Standard provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 12	V
$I_D @ T_c=25^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V$	45	A
$I_D @ T_c=125^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V$	20	A
I_{DM}	Pulsed Drain Current ¹	140	A
$P_D @ T_c=25^\circ C$	Total Power Dissipation	48	W
	Linear Derating Factor	0.38	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-c}	Thermal Resistance Junction-case	Max. 2.6	°C/W
R_{thj-a}	Thermal Resistance Junction-ambient	Max. 110	°C/W

Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	20	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	-	0.1	-	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=18\text{A}$	-	-	14	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=9\text{A}$	-	-	28	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	0.5	-	1.2	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=18\text{A}$	-	26	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	uA
	Drain-Source Leakage Current ($T_j=125^\circ\text{C}$)	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	-	-	25	uA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}= \pm 12\text{V}$	-	-	+100	nA
Q_g	Total Gate Charge ²	$I_{\text{D}}=18\text{A}$	-	19	-	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=20\text{V}$	-	1.5	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{\text{GS}}=5\text{V}$	-	10.5	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ²	$V_{\text{DS}}=10\text{V}$	-	7.5	-	ns
t_r	Rise Time	$I_{\text{D}}=18\text{A}$	-	83	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$R_{\text{C}}=3.3\Omega, V_{\text{GS}}=5\text{V}$	-	18	-	ns
t_f	Fall Time	$R_{\text{D}}=0.56\Omega$	-	23	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	500	-	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=20\text{V}$	-	310	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	125	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_s	Continuous Source Current (Body Diode)	$V_D=V_G=0\text{V}, V_S=1.3\text{V}$	-	-	45	A
I_{SM}	Pulsed Source Current (Body Diode) ¹		-	-	140	A
V_{SD}	Forward On Voltage ²	$T_j=25^\circ\text{C}, I_s=45\text{A}, V_{\text{GS}}=0\text{V}$	-	-	1.3	V

Notes:

- 1.Pulse width limited by safe operating area.
- 2.Pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.

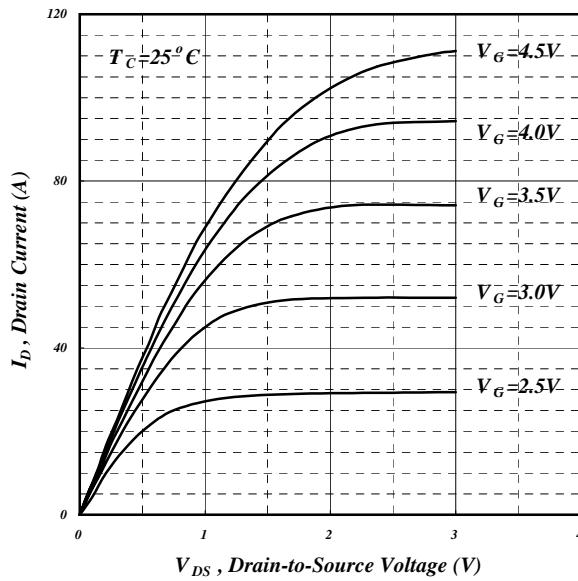


Fig 1. Typical Output Characteristics

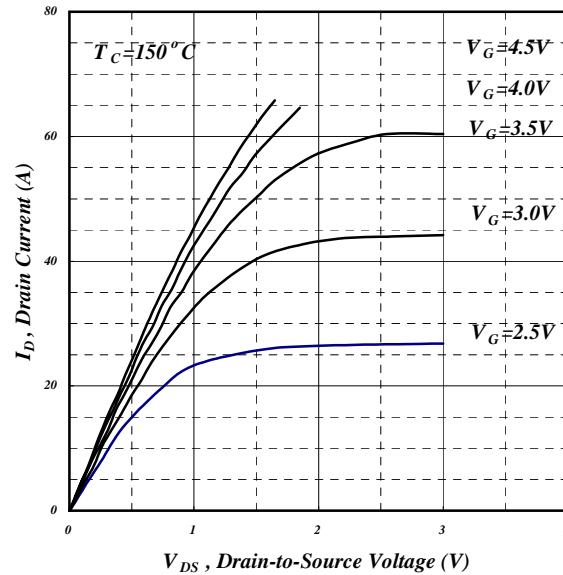


Fig 2. Typical Output Characteristics

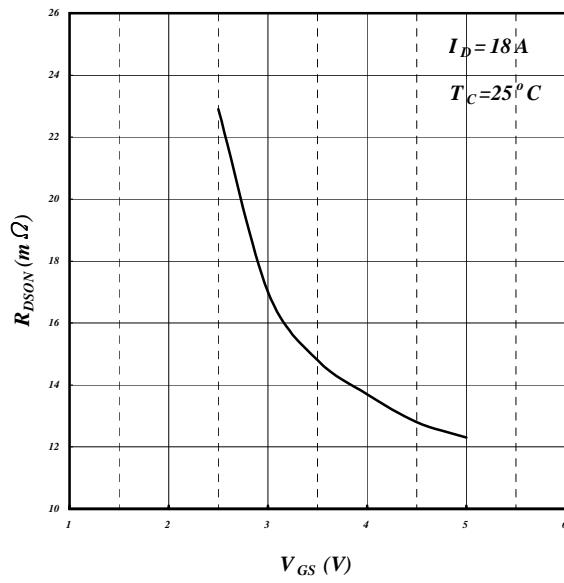


Fig 3. On-Resistance v.s. Gate Voltage

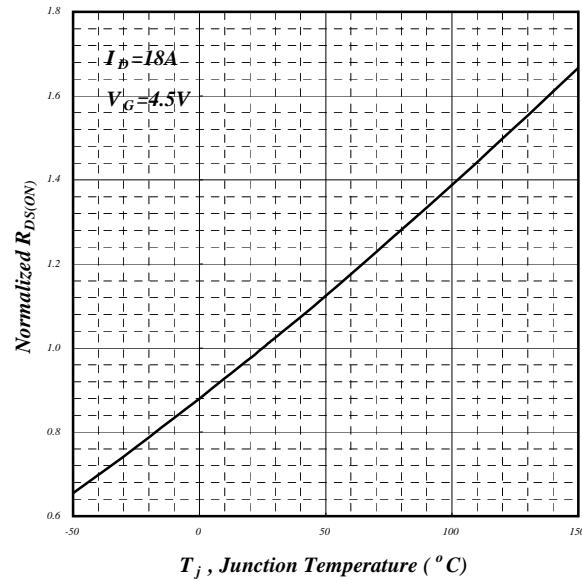
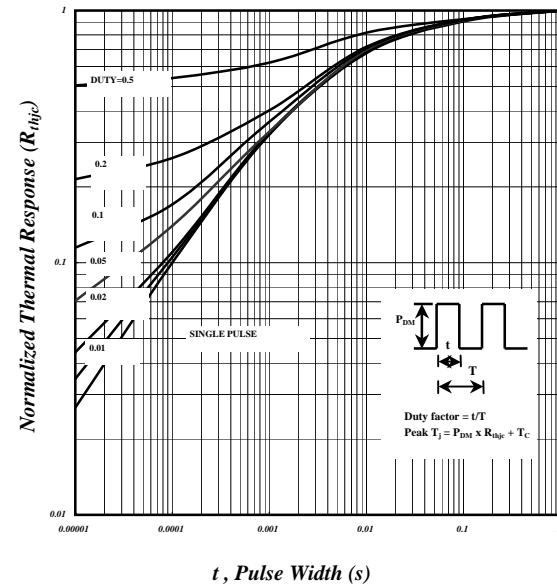
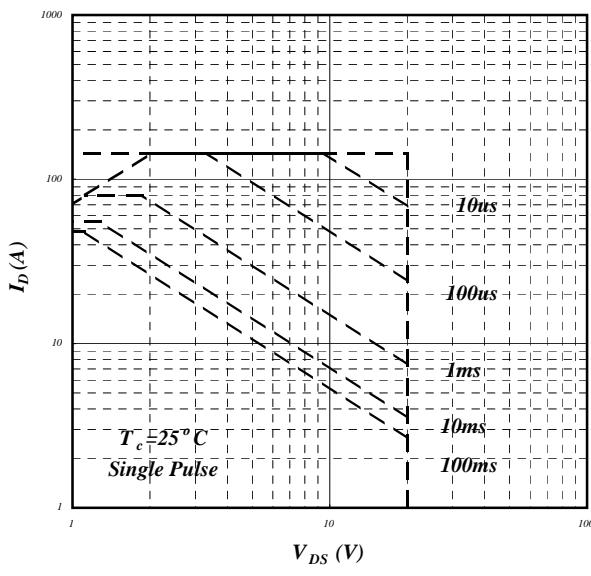
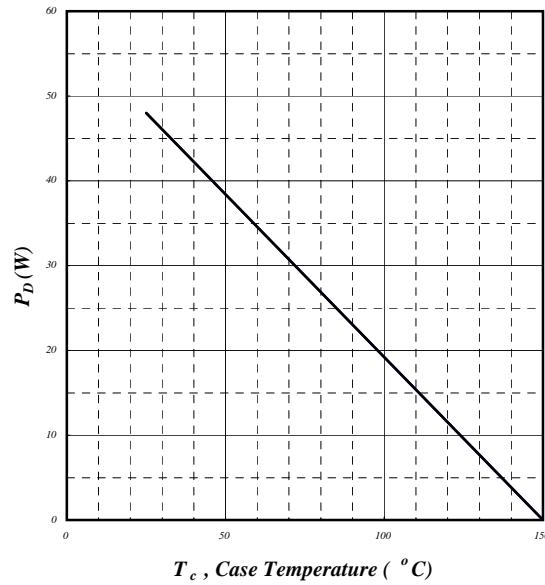
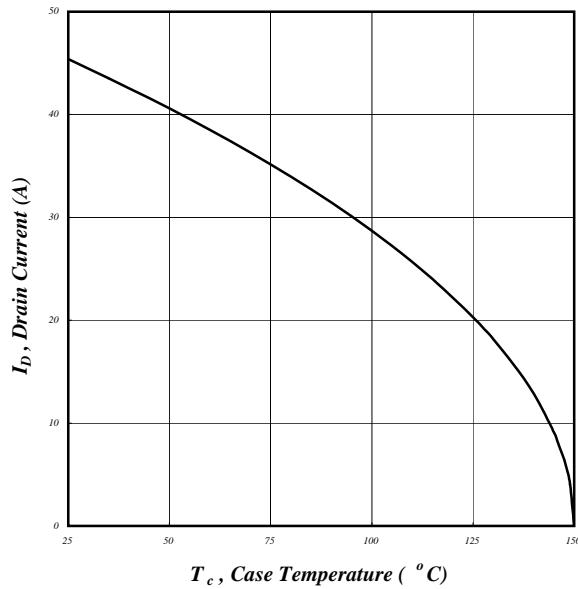


Fig 4. Normalized On-Resistance v.s. Junction Temperature



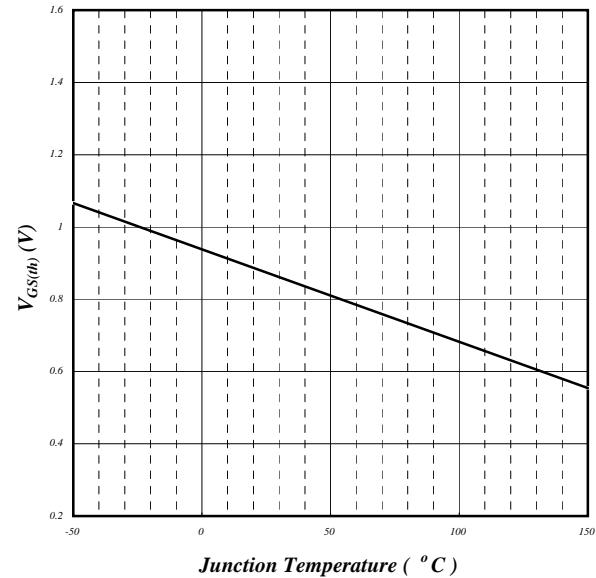
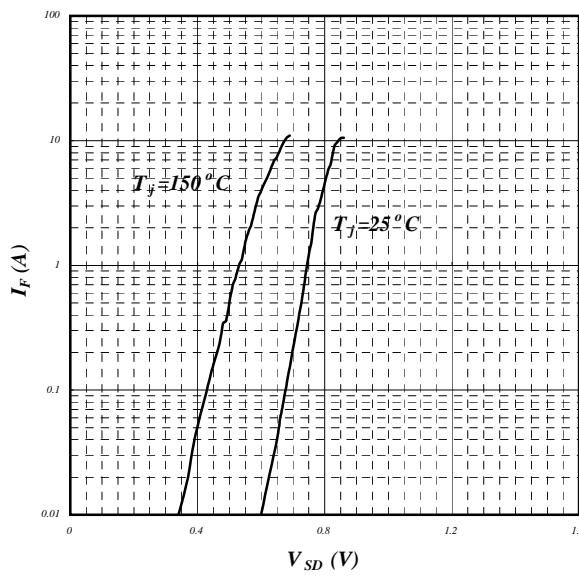
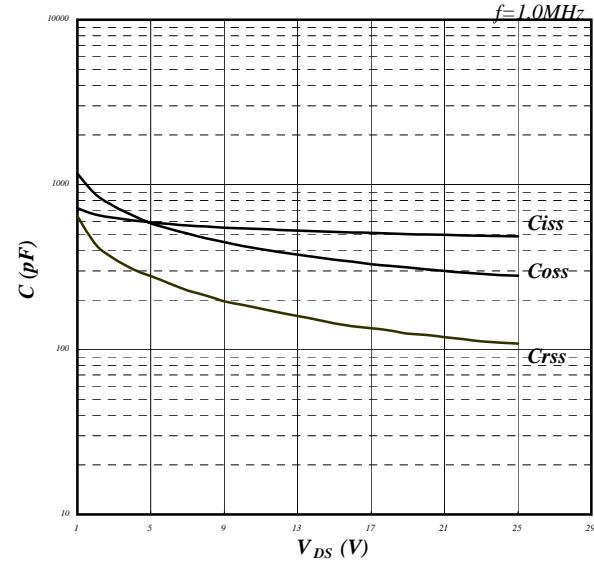
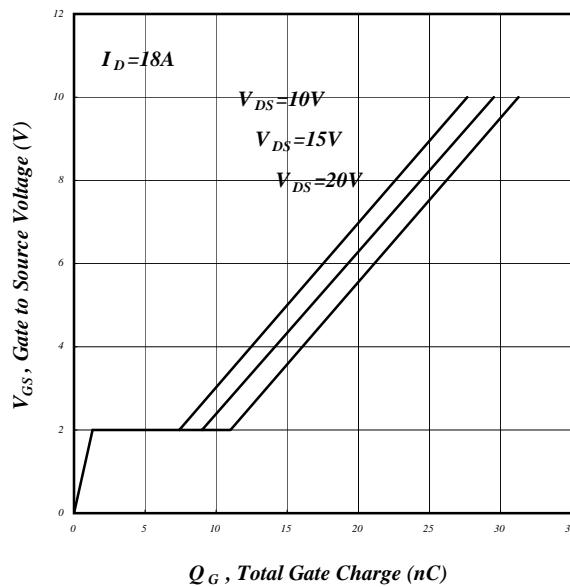
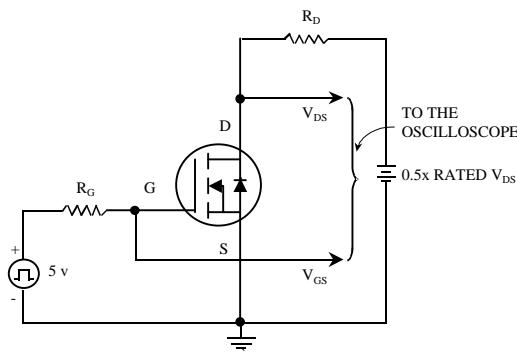
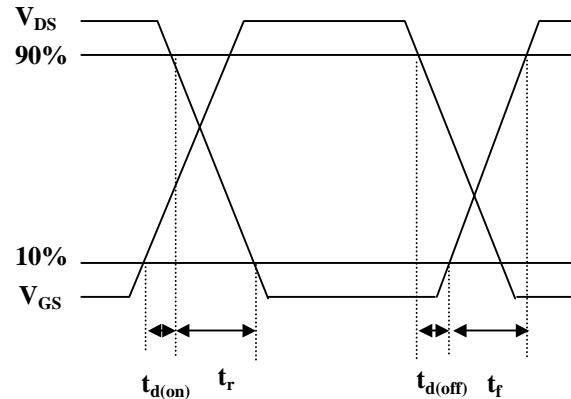
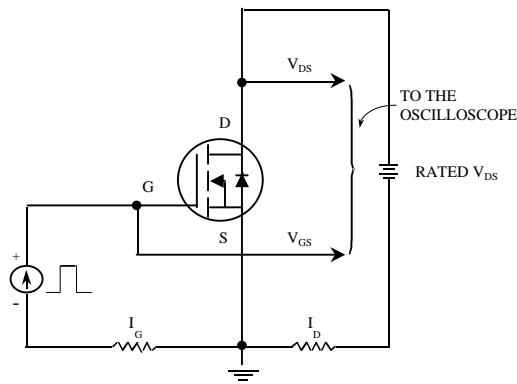
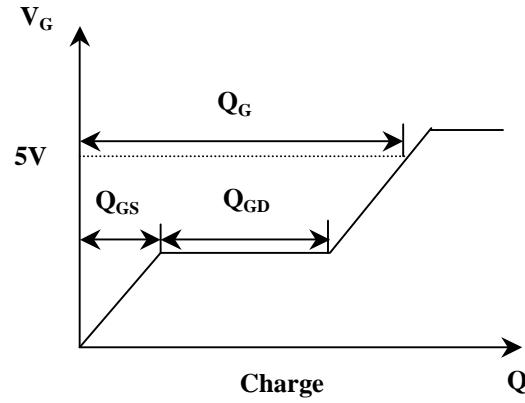


Fig 11. Forward Characteristic of Reverse Diode

Fig 12. Gate Threshold Voltage v.s. Junction Temperature

**Fig 13. Switching Time Circuit****Fig 14. Switching Time Waveform****Fig 15. Gate Charge Circuit****Fig 16. Gate Charge Waveform**

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